

# EFR32BG22E Wireless Gecko SoC Family Data Short



The EFR32BG22E Wireless Gecko family of SoCs is part of the Wireless Gecko portfolio. EFR32BG22E Wireless Gecko SoCs are ideal for enabling energy-friendly Bluetooth 5 networking for IoT devices that require fast startup.

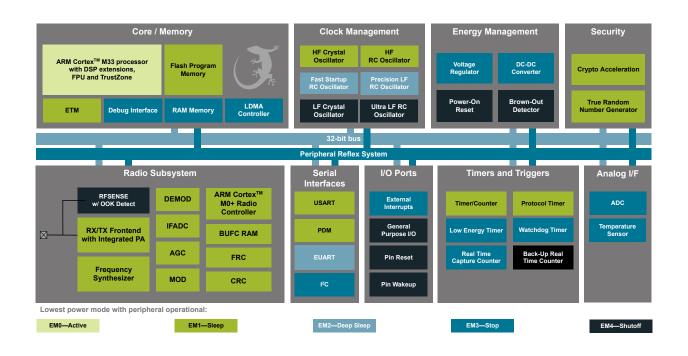
The single-die solution combines a 76.8 MHz Cortex-M33 with a high performance 2.4 GHz radio to provide an industry-leading, energy efficient, wireless SoC for IoT connected energy constrained applications.

Wireless Gecko applications include:

- · Asset Tags and Beacons, Ambient IoT
- · Consumer Electronics Remote Controls
- · Portable Medical, Sports, Fitness, and Wellness devices
- · Bluetooth Mesh Low Power Nodes
- Connected Home, Energy Harvest Home Appliances
- · Building Automation and Security
- · Energy Harvesting Applications
- TPMS / TMS (Tire Pressure Sensors)

#### **KEY FEATURES**

- 32-bit ARM® Cortex®-M33 core with 76.8 MHz maximum operating frequency
- · Up to 512 kB of flash and 32 kB of RAM
- Energy-efficient radio core with low active and sleep currents
- Bluetooth 5 Direction Finding
- Integrated PA with up to 6 dBm (2.4 GHz) TX power
- Fast cold start boot time and wake-up from EM4





#### 1. Feature List

The EFR32BG22E highlighted features are listed below.

#### · Low Power Wireless System-on-Chip

- High Performance 32-bit 76.8 MHz MHz ARM Cortex<sup>®</sup>-M33 with DSP instruction and floating-point unit for efficient signal processing
- · Up to 512 kB flash program memory
- Up to 32 kB RAM data memory
- · 2.4 GHz radio operation

#### Radio Performance

- · -106.7 dBm sensitivity @ 125 kbps GFSK
- · -98.9 dBm sensitivity @ 1 Mbit/s GFSK
- · -96.2 dBm sensitivity @ 2 Mbit/s GFSK
- · TX power up to 6 dBm
- · 2.5 mA radio receive current
- 3.4 mA radio transmit current @ 0 dBm output power
- 7.5 mA radio transmit current @ 6 dBm output power

# · Low System Energy Consumption

- · 3.6 mA RX current (1 Mbps GFSK)
- 4.1 mA TX current @ 0 dBm output power
- · 8.2 mA TX current @ 6 dBm output power
- 27 µA/MHz in Active Mode (EM0) at 76.8 MHz
- 1.40 µA EM2 DeepSleep current (32 kB RAM retention and RTC running from LFXO)
- 1.75 µA EM2 DeepSleep current (32 kB RAM retention and RTC running from Precision LFRCO)
- 0.17 µA EM4 current

# · Supported Modulation Format

- · 2 (G)FSK with fully configurable shaping
- OQPSK DSSS
- (G)MSK

# · Protocol Support

- Bluetooth Low Energy (Bluetooth 5)
- Direction finding using Angle-of-Arrival (AoA) and Angle-of-Departure (AoD)
- Proprietary

# Quality

· AEC-Q100 Qualification including AEC-Q006

#### · Fast boot and wake-up

- · Fast cold start boot time
- · Fast wake-up from EM4

#### Wide selection of MCU peripherals

- · Analog to Digital Converter (ADC)
  - 12-bit @ 1 Msps
  - · 16-bit @ 76.9 ksps
- Up to 26 General Purpose I/O pins with output state retention and asynchronous interrupts
- · 8 Channel DMA Controller
- · 12 Channel Peripheral Reflex System (PRS)
- 4 × 16-bit Timer/Counter with 3 Compare/Capture/PWM channels
- 1 × 32-bit Timer/Counter with 3 Compare/Capture/PWM channels
- · 32-bit Real Time Counter
- · 24-bit Low Energy Timer for waveform generation
- · 1 × Watchdog Timer
- 2 × Universal Synchronous/Asynchronous Receiver/Transmitter (UART/SPI/SmartCard (ISO 7816)/IrDA/I<sup>2</sup>S)
- 1 × Enhanced Universal Asynchronous Receiver/Transmitter (EUART)
- 2 × I<sup>2</sup>C interface with SMBus support
- · Digital microphone interface (PDM)
- Precision Low-Frequency RC Oscillator to replace 32 kHz sleep crystal
- · RFSENSE with selective OOK mode
- Die temperature sensor with +/-1.5 degree C accuracy after single-point calibration

# · Wide Operating Range

- 1.71 V to 3.8 V single power supply
- -40 °C to 125 °C

# Security Features

- Hardware Cryptographic Acceleration for AES128/256, SHA-1, SHA-2 (up to 256-bit), ECC (up to 256-bit), ECDSA, and ECDH
- True Random Number Generator (TRNG) compliant with NIST SP800-90 and AIS-31
- ARM<sup>®</sup> TrustZone<sup>®</sup>

#### Packages

- QFN40 5 mm × 5 mm × 0.85 mm
- QFN32 4 mm × 4 mm × 0.85 mm

# 2. Ordering Information

**Table 2.1. Ordering Information** 

Ordering Code	Protocol Stack	Max TX Power	Max CPU Speed	LFRCO	Flash (kB)	RAM (kB)	GPIO	Package	Temp Range
EFR32BG22E224F512IM40-C	Bluetooth     5.x     Direction     Finding     (AoA     Transmitter)     Proprietary	6 dBm	76.8 MHz	Precision	512	32	26	QFN40	-40 to 125 °C
EFR32BG22E224F512IM32-C	Bluetooth     5.x     Direction     Finding     (AoA     Transmitter)     Proprietary	6 dBm	76.8 MHz	Precision	512	32	18	QFN32	-40 to 125 °C

# Note:

- 1. LE Long Range (125 kbps and 500 kbps) PHYs are only supported on part numbers which include AoA/AoD direction-finding capability.
- 2. Bluetooth 5.x: As the Bluetooth standard evolves, Silicon Labs is regularly adding new features. For more information on supported Bluetooth capabilities, visit https://www.silabs.com/bluetooth-hardware.

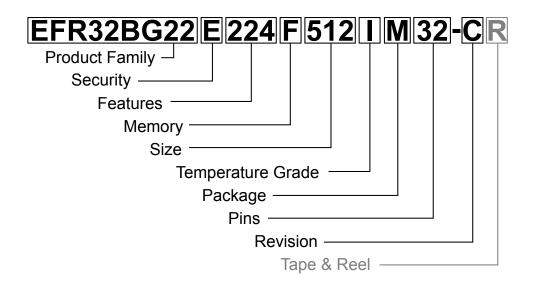
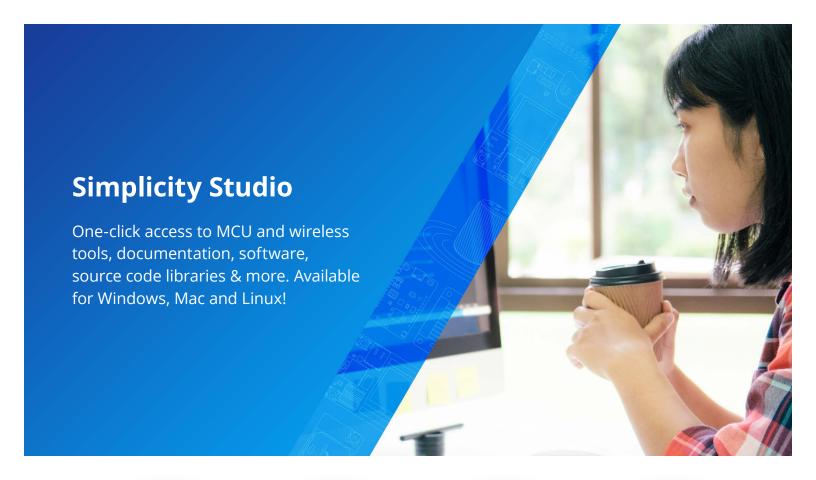


Figure 2.1. Ordering Code Key

Field	Options				
Product Family	EFR32BG22: Gecko 22 Family				
Security	• E: Base Security				
Features [f1][f2][f3]	<ul> <li>f1</li> <li>1: MCU Frequency of 38.4 MHz</li> <li>2: MCU Frequency of 76.8 MHz</li> <li>f2</li> <li>1: 0 dBm output power</li> <li>2: 6 dBm output power</li> <li>f3</li> <li>1: No Direction finding, without Precision LFRCO</li> <li>2: No Direction finding, with Precision LFRCO</li> <li>3: Direction finding, without Precision LFRCO</li> <li>4: Direction finding, with Precision LFRCO</li> </ul>				
Memory	• F: Flash				
Size	Memory Size in kBytes				
Temperature Grade	• <b>G</b> : -40 to +85 °C • <b>I</b> : -40 to +125 °C				
Package	• M: QFN				
Pins	Number of Package Pins				
Revision	• C: Revision C				
Tape & Reel	• R: Tape & Reel (optional)				





**IoT Portfolio** www.silabs.com/IoT



SW/HW www.silabs.com/simplicity



Quality www.silabs.com/quality



**Support & Community** www.silabs.com/community

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